



FEMTOCLOCK™ LVCMOS/LVTTL CLOCK GENERATOR

ICS840001I-25

GENERAL DESCRIPTION



The ICS840001I-25 is a General Purpose Clock Generator and a member of the HiPerClocks™ family of high performance devices from IDT. The ICS840001I-25 can accept frequency from a 22.4MHz to 170MHz and generate a 22.4MHz to 170MHz output. The ICS840001I-25 has excellent phase jitter performance, from 637kHz – 10MHz integration range. The ICS840001I-25 is packaged in a small 8-pin TSSOP, making it ideal for use in systems with limited board space.

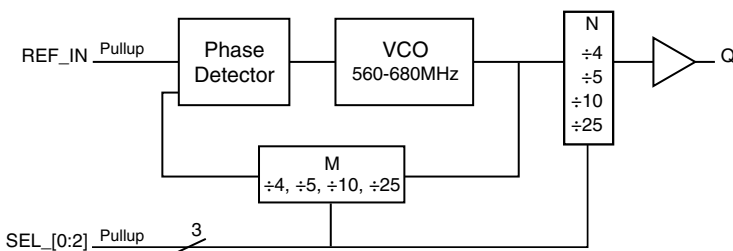
FEATURES

- One LVCMOS/LVTTL output, 15Ω output impedance
- Output frequency range: 22.4MHz – 170MHz
- VCO range: 560MHz to 680MHz
- RMS phase jitter @ 125MHz (637kHz - 10MHz): 0.36ps (typical)
- Full 3.3V or 2.5V operating supply
- -40°C to 85°C ambient operating temperature
- Available in both standard (RoHS 5) and lead-free (RoHS 6) packages

COMMONLY USED FREQUENCY TABLE

Inputs						Output Frequency (MHz)
SEL2	SEL1	SEL0	M Divider	N Divider	REF_IN (MHz)	Q
0	0	0	25	25	25	25
0	0	1	10	25	62.5	25
0	1	0	4	25	156.25	25
0	1	1	5	25	125	25
1	0	0	10	10	62.5	62.5
1	0	1	5	5	125	125
1	1	0	4	4	156.25	156.25
1	1	1	10	25	62.5	25 (default)

BLOCK DIAGRAM



PIN ASSIGNMENT

VDD	1	8	Q
REF_IN	2	7	VDDO
SEL_0	3	6	GND
SEL_1	4	5	SEL_2

ICS840001I-25

8-Lead TSSOP

4.40mm x 3.0mm x 0.925mm package body

G Package

Top View

TABLE 1. PIN DESCRIPTIONS

Number	Name	Type		Description
1	V_{DD}	Power		Positive supply pin.
2	REF_IN	Input	Pullup	Reference input frequency. LVCMOS/LVTTL interface levels.
3, 4, 5	SEL_0, SEL_1, SEL_2	Input	Pullup	M and N configuration select pins. LVCMOS/LVTTL interface levels.
6	GND	Power		Power supply ground.
7	V_{DDO}	Power		Output supply pin.
8	Q	Output		Single-ended clock output. LVCMOS/LVTTL interface levels. 15 Ω output impedance.

NOTE: *Pullup* refers to internal input resistors. See Table 2, Pin Characteristics, for typical values.

TABLE 2. PIN CHARACTERISTICS

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C_{IN}	Input Capacitance			4		pF
C_{PD}	Power Dissipation Capacitance	$V_{DD}, V_{DDO} = 3.465V$		6		pF
		$V_{DD}, V_{DDO} = 2.625V$		5		pF
R_{PULLUP}	Input Pullup Resistor			51		k Ω
R_{OUT}	Output Impedance			15		Ω

ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD}	4.6V
Inputs, V_I	-0.5V to $V_{DD} + 0.5V$
Outputs, V_O	-0.5V to $V_{DDO} + 0.5V$
Package Thermal Impedance, θ_{JA}	129.5°C/W (0 mps)
Storage Temperature, T_{STG}	-65°C to 150°C

NOTE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characteristics* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

TABLE 3A. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = V_{DDO} = 3.3V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Positive Supply Voltage		3.135	3.3	3.465	V
V_{DDO}	Output Supply Voltage		3.135	3.3	3.465	V
I_{DD}	Power Supply Current				83	mA
I_{DDO}	Output Supply Current	No Load			2	mA

TABLE 3B. POWER SUPPLY DC CHARACTERISTICS, $V_{DD} = V_{DDO} = 2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Positive Supply Voltage		2.375	2.5	2.625	V
V_{DDO}	Output Supply Voltage		2.375	2.5	2.625	V
I_{DD}	Power Supply Current				80	mA
I_{DDO}	Output Supply Current	No Load			2	mA

TABLE 3C. LVCMOS/LVTTL DC CHARACTERISTICS, $V_{DD} = V_{DDO} = 3.3V \pm 5\%$ OR $2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{IH}	Input High Voltage	$V_{DD} = 3.465V$	2		$V_{DD} + 0.3$	V
		$V_{DD} = 2.625V$	1.7		$V_{DD} + 0.3$	V
V_{IL}	Input Low Voltage	$V_{DD} = 3.465V$	-0.3		0.8	V
		$V_{DD} = 2.625V$	-0.3		0.7	V
I_{IH}	Input High Current	REF_IN, SEL_[0:2] $V_{DD} = V_{IN} = 3.465V$ or $2.625V$			5	μA
I_{IL}	Input Low Current	REF_IN, SEL_[0:2] $V_{DD} = 3.465V$ or $2.625V$, $V_{IN} = 0V$	-150			μA
V_{OH}	Output High Voltage; NOTE 1	$V_{DDO} = 3.465V$	2.6			V
		$V_{DDO} = 2.625V$	1.8			V
V_{OL}	Output Low Voltage; NOTE 1	$V_{DDO} = 3.465V$ or $2.625V$			0.6	V

NOTE 1: Outputs terminated with 50Ω to $V_{DDO}/2$. See Parameter Measurement Information Section, "Output Load Test Circuit" diagrams.

TABLE 4A. AC CHARACTERISTICS, $V_{DD} = V_{DDO} = 3.3V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{OUT}	Output Frequency		22.4		170	MHz
$f_{jit}(\emptyset)$	RMS Phase Jitter (Random); NOTE 1	125MHz, Integration Range: 637kHz - 10MHz		0.37		ps
		156.25MHz, Integration Range: 637kHz - 10MHz		0.38		ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	150		650	ps
odc	Output Duty Cycle		47		53	%

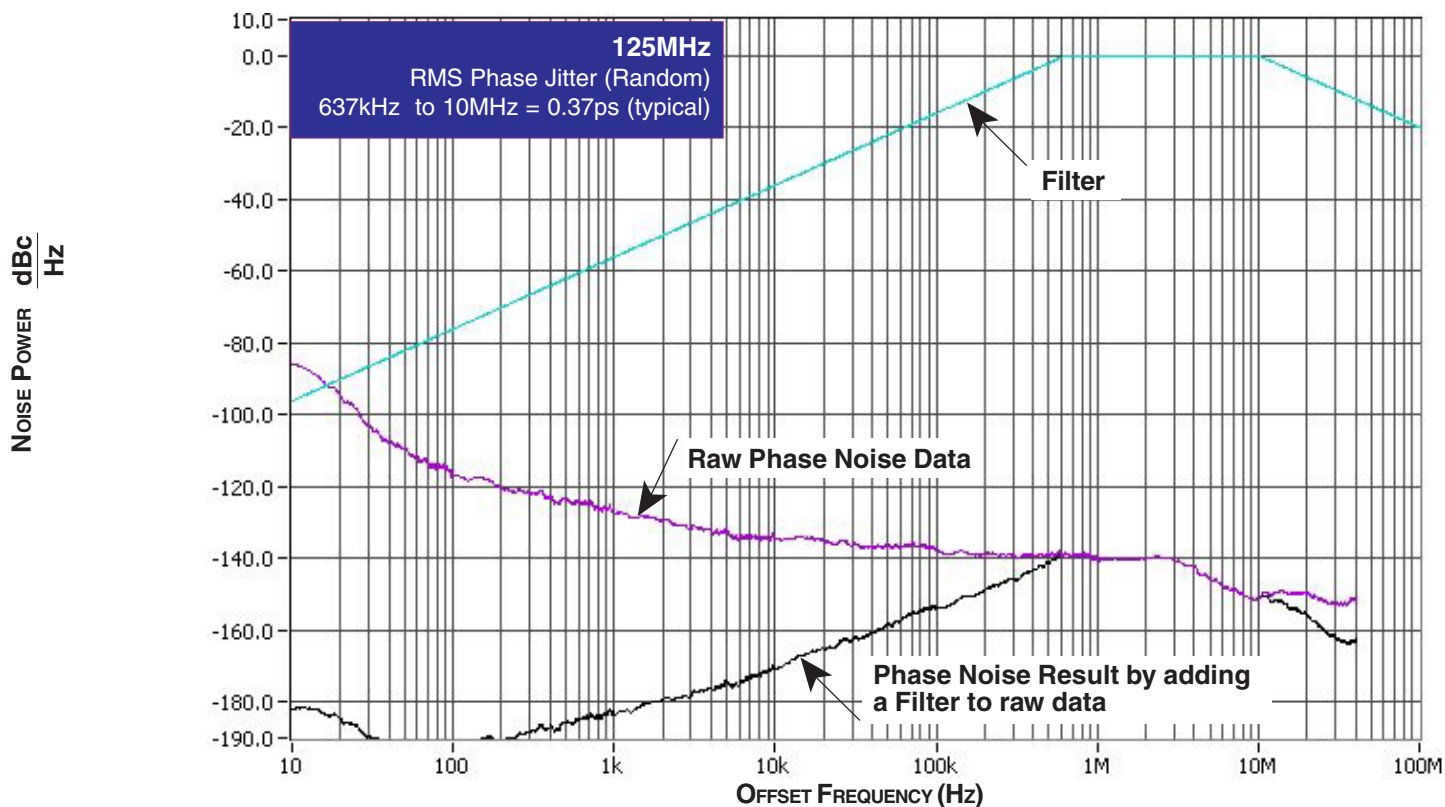
NOTE 1: Please refer to the Phase Noise Plot.

TABLE 4B. AC CHARACTERISTICS, $V_{DD} = V_{DDO} = 2.5V \pm 5\%$, $T_A = -40^\circ\text{C}$ TO 85°C

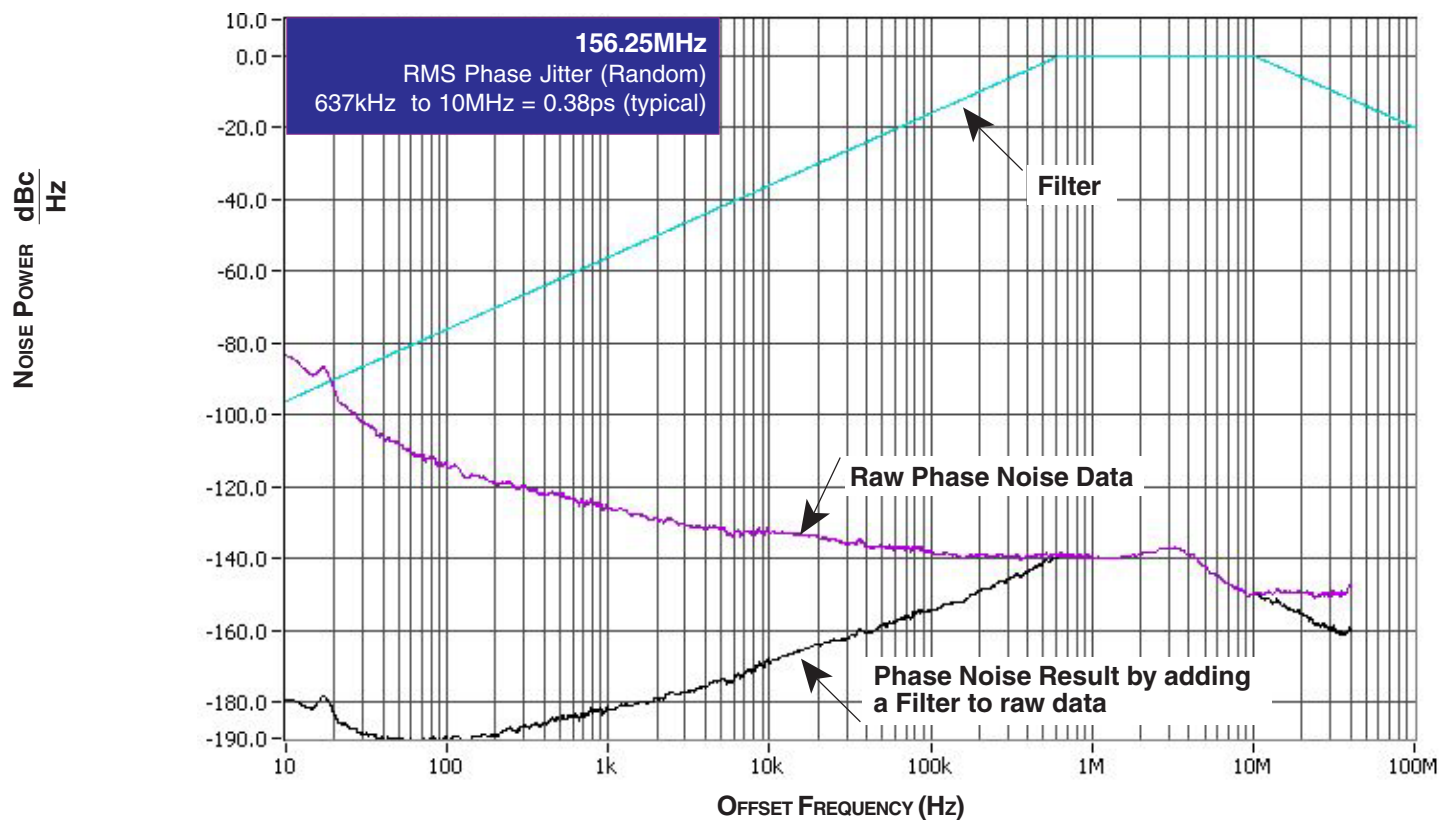
Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
f_{OUT}	Output Frequency		22.4		170	MHz
$f_{jit}(\emptyset)$	RMS Phase Jitter (Random); NOTE 1	125MHz, Integration Range: 637kHz - 10MHz		0.36		ps
		156.25MHz, Integration Range: 637kHz - 10MHz		0.35		ps
t_R / t_F	Output Rise/Fall Time	20% to 80%	150		650	ps
odc	Output Duty Cycle		47		53	%

NOTE 1: Please refer to the Phase Noise Plot.

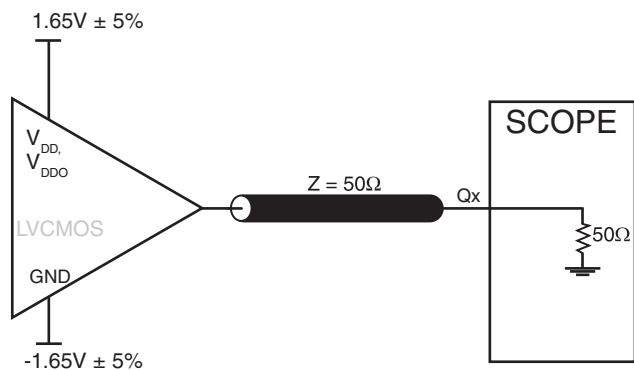
TYPICAL PHASE NOISE AT 125MHz @ 3.3V



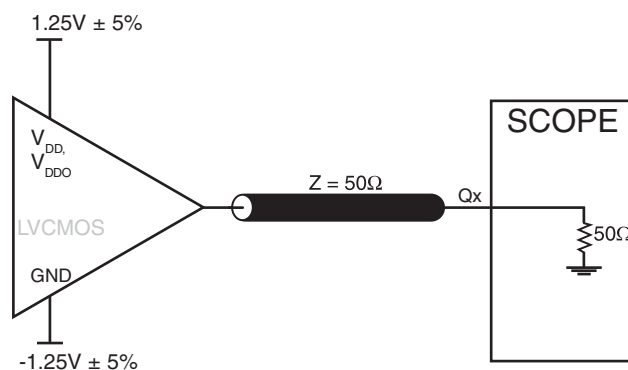
TYPICAL PHASE NOISE AT 156.25MHz @ 3.3V



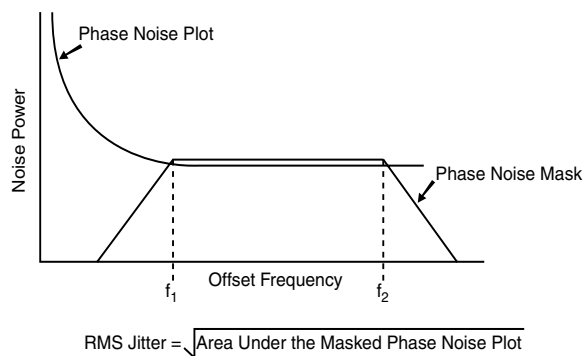
PARAMETER MEASUREMENT INFORMATION



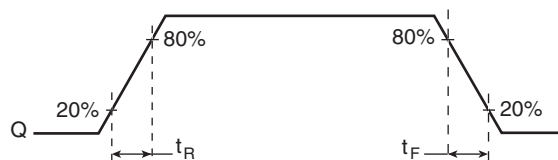
3.3V OUTPUT LOAD AC TEST CIRCUIT



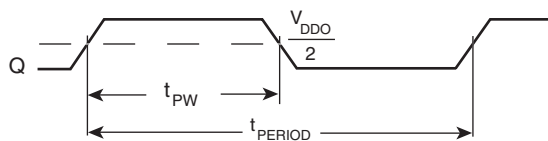
2.5V OUTPUT LOAD AC TEST CIRCUIT



RMS PHASE JITTER



OUTPUT RISE/FALL TIME



$$\text{odc} = \frac{t_{PW}}{t_{PERIOD}} \times 100\%$$

OUTPUT DUTY CYCLE/PULSE WIDTH/PERIOD

APPLICATION INFORMATION

RECOMMENDATIONS FOR UNUSED INPUT PINS

INPUTS:

LVCMOS CONTROL PINS:

All control pins have internal pullups or pulldowns; additional resistance is not required but can be added for additional protection. A 1k Ω resistor can be used.

POWER CONSIDERATIONS

This section provides information on power dissipation and junction temperature for the ICS840001I-25. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the ICS840001I-25 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for $V_{DD} = 3.3V + 5\% = 3.465V$, which gives worst case results.

Core and Output Power Dissipation

- Power (core, output) = $V_{DD_MAX} * (I_{DD} + I_{DDO}) = 3.465V * (83mA + 2mA) = \mathbf{294.5mW}$

LVCMOS Output Power Dissipation

- Output Impedance R_{OUT} Power Dissipation due to Loading 50Ω to $V_{DDO}/2$
Output Current $I_{OUT} = V_{DDO_MAX} / [2 * (50\Omega + R_{OUT})] = 3.465V / [2 * (50\Omega + 15\Omega)] = \mathbf{26.6mA}$
- Power Dissipation on the R_{OUT} per LVCMOS output
Power (R_{OUT}) = $R_{OUT} * (I_{OUT})^2 = 15\Omega * (26.6mA)^2 = \mathbf{10.6mW}$ per output
- Dynamic Power Dissipation at 156.25MHz
Power (156.25MHz) = $C_{PD} * Frequency * (V_{DDO})^2 = 6pF * 156.25MHz * (3.465V)^2 = \mathbf{11.26mW}$ per output

Total Power Dissipation

- Total Power**
= Power (core, output) + Power Dissipation (R_{OUT}) + Dynamic Power Dissipation (156.25MHz)
= $294.5mW + 10.6mW + 11.26mW$
= $\mathbf{316.4mW}$

2. Junction Temperature.

Junction temperature, T_j , is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS™ devices is 125°C.

The equation for T_j is as follows: $T_j = \theta_{JA} * Pd_total + T_A$

T_j = Junction Temperature

θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 1 meter per second and a multi-layer board, the appropriate value is 125.5°C/W per Table 5.

Therefore, T_j for an ambient temperature of 85°C with all outputs switching is:

$85^\circ\text{C} + 0.316\text{W} * 125.5^\circ\text{C/W} = 124.7^\circ\text{C}$. This is below the limit of 125°C.

This calculation is only an example. T_j will obviously vary depending on the number of loaded outputs, supply voltage, air flow, and the type of board (multi-layer).

TABLE 5. THERMAL RESISTANCE θ_{JA} FOR 8-LEAD TSSOP, FORCED CONVECTION

θ_{JA} by Velocity (Meters Per Second)			
	0	1	2.5
Multi-Layer PCB, JEDEC Standard Test Boards	129.5°C/W	125.5°C/W	123.5°C/W

RELIABILITY INFORMATION

TABLE 6. θ_{JA} VS. AIR FLOW TABLE FOR 8 LEAD TSSOP

θ_{JA} by Velocity (Meters Per Second)			
	0	1	2.5
Multi-Layer PCB, JEDEC Standard Test Boards	129.5°C/W	125.5°C/W	123.5°C/W

TRANSISTOR COUNT

The transistor count for ICS840001I-25 is: 2588

PACKAGE OUTLINE AND PACKAGE DIMENSIONS

PACKAGE OUTLINE - G SUFFIX FOR 8 LEAD TSSOP

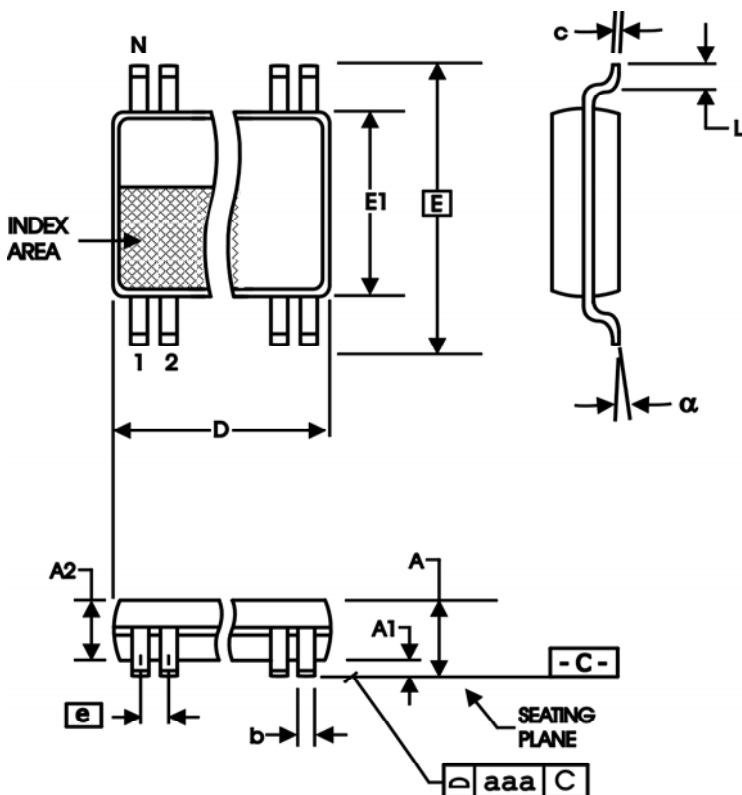


TABLE 7. PACKAGE DIMENSIONS

SYMBOL	Millimeters	
	Minimum	Maximum
N	8	
A	--	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	2.90	3.10
E	6.40 BASIC	
E1	4.30	4.50
e	0.65 BASIC	
L	0.45	0.75
α	0°	8°
aaa	--	0.10

Reference Document: JEDEC Publication 95, MO-153

TABLE 8. ORDERING INFORMATION

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
840001BGI-25	1BI25	8 lead TSSOP	tube	-40°C to 85°C
840001BGI-25T	1BI25	8 lead TSSOP	2500 tape & reel	-40°C to 85°C
840001BGI-25LF	BI25L	8 lead "Lead Free" TSSOP	tube	-40°C to 85°C
840001BGI-25LFT	BI25L	8 lead "Lead Free" TSSOP	2500 tape & reel	-40°C to 85°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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